## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Cavallaro et al.	CERTIFICATE OF MAILING BY "EXPRESS MAIL"
Appln No.:		) "Express Mail" Mailing Label Number
	•	EV 214 707 752 US
Filed:	Herewith	) Date of Deposit <u>July 10, 2003</u>
Title:	SILICONE DISPENSING WITH A CONFOMAL FILM	) I hereby certify that this paper or fee is being deposited with sufficient postage utilizing the United States Postal Service "Express Mail Post Office to Addressee" Service under 37 CFR §1.10 on the date indicated above and
Group Art Unit:		) is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.
CIME.		(Typed or printed name of person mailing)
Examiner:		(Signature of person mailing)
		)

## **INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with 37 CFR §§ 1.97 and 1.98, Applicants bring the following information with respect to the above-identified application to the attention of the Examiner.

## **U.S. Patent Documents**

US-6,333,117	12/25/2001	Sumi et al.
US-6,103,271	08/15/2000	Morrison et al.
US-5,910,314	06/08/1999	Benoff et al.
US-5,759,560	06/02/1998	Dillon
US-5,705,174	01/06/1998	Benoff et al.
US-5,407,609	04/18/1995	Tice et al.
US-5,310,721	05/10/1994	Lo
US-4,389,330	06/21/1983	Tice et al.
US-4,384,975	05/24/1983	Fong
US-4,280,833	07/28/1981	Beestman et al.
US-3,891,570	06/24/1975	Fukushima et al.
US-3,577,515	05/04/1971	Vandegaer

## **Non-Patent Literature Documents**

Nakai et al., "Large Area Micro-Encapsulated Reflective Guest-Host LCDs and Their Applications", Display Materials and Devices Laboratory, Corporate Research and Development Center, Toshiba Corp.

"Microencapsulation Technology", 3M, 1996

Franjione et al. "The Art and Science of Microencapsulation", Technology Today, 1995

"Microencapsulation", Southwest Research Institute, San Antonio, Texas, May 2002

"Microencapsulation", Ciba Speciality Chemicals, www.cibasc.com

"What is Microencapsulation", Thies Techology, www.thiestechnology.com

"Ink Gets an Upgrade", EDN Access, www.e-insite.net

"The European Biomaterials Network, Drug Delivery and Citus's New Microspheres, Microcapsules and Liposomes (MML) Series, <u>www.biomateria.com</u>

Versic, "Flavor Encapsulation", ACS Symposium, Series No. 370. 1998, www.rtdodge.com

"Microcapsules", Nirotek Coated Paper Mfg., www.nirotek.com

"Microcapsules", Brace GmbH, www.brace.de

"Lucent, E Ink Developing E-Books Using Bell Labs Plastic Transistors", www.bell-labs.com

The above documents are listed on Form PTO/SB/08 which accompanies this Information Disclosure Statement, and a copy of each document listed is enclosed herewith.

Pursuant to 37 CFR § 1.97(h), the filing of this Information Disclosure Statement shall not be construed to be an admission that the information cited in the statement is, or is considered to be, material to patentability as defined in 37 CFR § 1.56(b).

Respectfully submitted,

FITCH, EVEN, TABIN & FLANNERY

James P. Krueger

Registration No. 35,234

Date: <u>July 10, 2003</u>

Suite 1600 120 South LaSalle Street Chicago, Illinois 60603-3406 (312) 577-7000

Substitute for Form PTO-1449  INFORMATION DISCLOSURE STATEMENT BY APPLICANT  (use as many sheets as necessary)			-	Application Number	
				Filing Date	Herewith
				First Named Inventor	Cavallaro et al.
			PPLICANT	Art Unit	
			necessary)	Examiner Name	
Sheet	1	of	2	Attorney Docket	CE09078R (74086)

			U.S. PATENT D	OCUMENTS	
Examiner Ci	Cite	Document Number	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear
Initials*	No. <sup>1</sup>	Number-Kind Code <sup>2</sup>	MM-DD-YYYY		
		US-6,333,117	12/25/2001	Sumi et al.	
		US-6,103,271	08/15/2000	Morrison et al.	
		US-5,910,314	06/08/1999	Benoff et al.	
		US-5,759,560	06/02/1998	Dillon	
		US-5,705,174	01/06/1998	Benoff et al.	
		US-5,407,609	04/18/1995	Tice et al.	
		US-5,310,721	05/10/1994	Lo	
		US-4,389,330	06/21/1983	Tice et al.	
		US-4,384,975	05/24/1983	Fong	
		US-4,280,833	07/28/1981	Beestman et al.	
		US-3,891,570	06/24/1975	Fukushima et al.	
		US-3,577,515	05/04/1971	Vandegaer	
		US-			
		US-			

		FORE	IGN PATENT D	OCUMENTS		
Examiner Initials*	Cite No.1	Foreign Patent Document	Publication Date	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	Γ
		Country Code³-Number⁴-Kind Code⁵	MM-DD-YYYY			Т
·						$\vdash$
						$\vdash$
					<u> </u>	$\vdash$
				<u></u> .		十
						Ħ
•						

Examiner Date Signature Considered

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Drawline through citation if not in conformance

and not considered. Include copy of this form with next communication to applicant.

¹ Applicant's unique citation designation number (optional). ² See Kind Codes of USPTO Patent Documents at <a href="https://www.uspto.gov">www.uspto.gov</a> or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

PTO/SB/08B				Application Number		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				Filing Date	Herewith	
				First Named Inventor	Cavallaro et al.	_
				Art Unit		
(use as many sheets as necessary)			cessary)	Examiner Name		
Sheet	2	of	2	Attorney Docket	CE09078R (74086)	

		NON PATENT LITERATURE DOCUMENTS					
Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	T²				
		Nakai et al., "Large Area Micro-Encapsulated Reflective Guest-Host LCDs and Their Applications", Display Materials and Devices Laboratory, Corporate Research and Development Center, Toshiba Corp.					
		"Microencapsulation Technology", 3M, 1996					
		Franjione et al. "The Art and Science of Microencapsulation", Technology Today, 1995					
		"Microencapsulation", Southwest Research Institute, San Antonio, Texas, May 2002					
		"Microencapsulation", Ciba Speciality Chemicals, www.cibasc.com					
		"What is Microencapsulation", Thies Techology, www.thiestechnology.com					
		"Ink Gets an Upgrade", EDN Access, www.e-insite.net					
		"The European Biomaterials Network, Drug Delivery and Citus's New Microspheres, Microcapsules and Liposomes (MML) Series, <u>www.biomateria.com</u>					
		Versic, "Flavor Encapsulation", ACS Symposium, Series No. 370. 1998, www.rtdodge.com					
		"Microcapsules", Nirotek Coated Paper Mfg., www.nirotek.com					
		"Microcapsules", Brace GmbH, www.brace.de					
		"Lucent, E Ink Developing E-Books Using Bell Labs Plastic Transistors", www.bell-labs.com					
Examine	<u>-</u>						
Signature		Date Considered					

<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

1 Applicant's unique citation designation number (optional). 2 Applicant is to place a check mark here if English language Translation is attached.